

v03.0223

GaAs pHEMT MMIC LOW NOISE AMPLIFIER, 7.5 - 26.5 GHz

Typical Applications

This HMC962LC4 is ideal for:

- · Point-to-Point Radios
- · Point-to-Multi-Point Radios
- Military & Space
- · Test Instrumentation

Features

Low Noise Figure: 2.5 dB

Gain: 13 dB

P1dB Output Power: 13 dBm

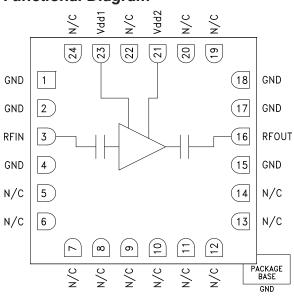
Single Supply Voltage: +3.5V @ 70mA

Output IP3: +23 dBm

50 Ohm matched Input/Output

24 Lead 4x4 mm SMT Package: 16mm²

Functional Diagram



General Description

The HMC962LC4 is a self-biased GaAs MMIC Low Noise Amplifier housed in a leadless 4x4 mm ceramic surface mount package. The amplifier operates between 7.5 and 26.5 GHz, providing 13 dB of small signal gain, 2.5 dB noise figure, and output IP3 of +23 dBm, while requiring only 70 mA from a +3.5 V supply. The P1dB output power of +13 dBm enables the LNA to function as a LO driver for balanced, I/Q or image reject mixers. The HMC962LC4 also features I/Os that are DC blocked and internally matched to 50 Ohms, making it ideal for high capacity microwave radios and VSAT applications.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd1 = Vdd2 = +3.5V, Idd = 70 mA

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range	7.5 - 10		10 - 24			24 - 26.5		GHz		
Gain	10	12		10	13		8	10		dB
Gain Variation over Temperature		0.027			0.024			0.024		dB/°C
Noise Figure [1]		2.5	3.7		2.5	3		2.7	3.7	dB
Input Return Loss		13			10			7		dB
Output Return Loss		10			12			11		dB
Output Power for 1 dB Compression		10			12			13		dBm
Saturated Output Power (Psat)		14			15			15		dBm
Output Third Order Intercept (IP3)		22			23			25		dBm
Supply Current (Idd) (Vdd = 3.5V)		70	95		70	95		70	95	mA

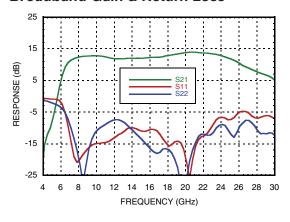
^[1] Board loss subtracted out.

AMPLIFIERS - LOW NOISE - SMI

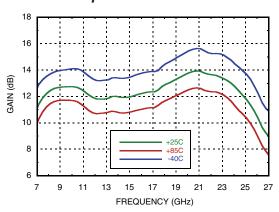




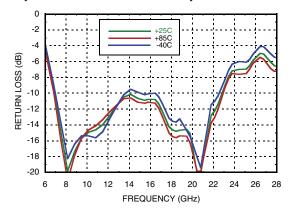
Broadband Gain & Return Loss



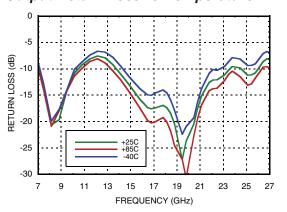
Gain vs. Temperature



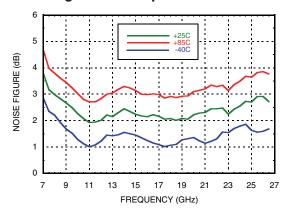
Input Return Loss vs. Temperature



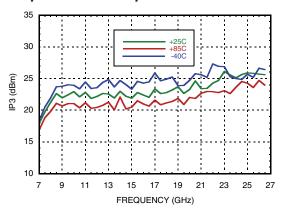
Output Return Loss vs. Temperature



Noise Figure vs. Temperature [1]



Output IP3 vs. Temperature

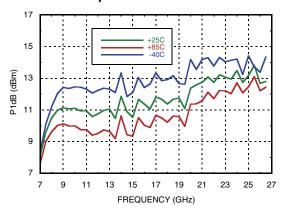


[1] Board loss subtracted out.

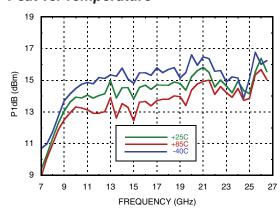




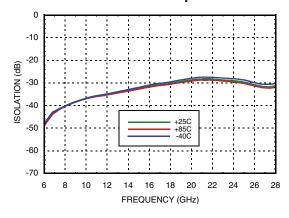
P1dB vs. Temperature



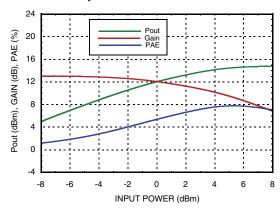
Psat vs. Temperature



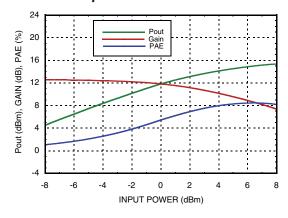
Reverse Isolation vs. Temperature



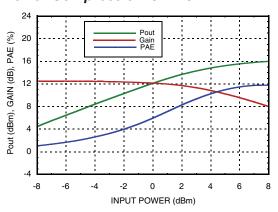
Power Compression @ 10 GHz



Power Compression @ 17 GHz



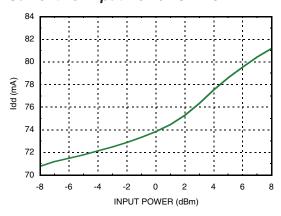
Power Compression @ 24 GHz







Current vs. Input Power @ 17 GHz



Absolute Maximum Ratings

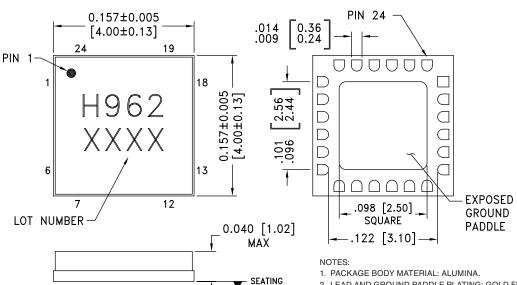
Drain Bias Voltage	+4V
RF Input Power	+10 dBm
Channel Temperature	150 °C
Continuous Pdiss (T = 85 °C) (derate 5.97 mW/°C above 85 °C)	0.39 W
Thermal Resistance (Channel to ground paddle)	167.6 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing

BOTTOM VIEW



PLANE

·C-

- 2. LEAD AND GROUND PADDLE PLATING: GOLD FLASH OVER NICKEL.
- 3. DIMENSIONS ARE IN INCHES (MILLIMETERS).
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05MM DATUM C -
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC962LC4	Alumina, White	Gold over Nickel	MSL3 ^[1]	H962 XXXX

^[1] Max peak reflow temperature of 260 $^{\circ}\text{C}$

^{[2] 4-}Digit lot number XXXX





Pin Descriptions

Pin Number	Function	Description	Interface Schematic	
1, 2, 4, 15, 17, 18	GND	These pins and package bottom must be connected to RF/DC ground.	⊖ GND =	
3	RFIN	This pin AC coupled and matched to 50 Ohms	RFIN O—	
5 - 14, 19, 20, 22, 24	N/C	No connection necessary. These pins may be connected to RF/DC ground. Performance will not be affected.		
16	RFOUT	This pin AC coupled and matched to 50 Ohms	RFOUT	
21, 23	Vdd1, Vdd2	Power supply voltages for the amplifier. Bypass capacitors are required. See application circuit herein.	Vdd1,2	

Application Circuit

